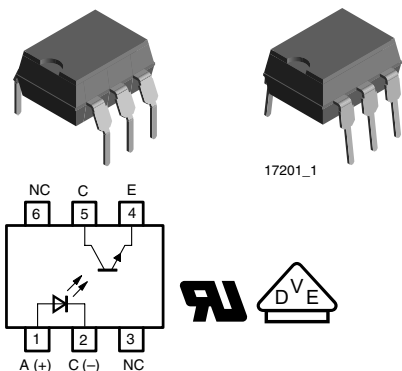


Optocoupler, Phototransistor Output



DESCRIPTION

The TCDT1100/TCDT1100G series consists of a phototransistor optically coupled to a gallium arsenide infrared-emitting diode in a 6-pin plastic dual inline package. The base of the phototransistor is not connected providing noise immunity.

The elements are mounted on one leadframe which providing a fixed distance between input and output for highest safety requirements.

VDE STANDARDS

These couplers perform safety functions according to the following equipment standards:

- **DIN EN 60747-5-5 pending**
Optocoupler for electrical safety requirements
- **IEC 60950/EN 60950**
Office machines (applied for reinforced isolation for mains voltage $\leq 400 V_{RMS}$)
- **VDE 0804**
Telecommunication apparatus and data processing
- **IEC 60065**
Safety for mains-operated electronic and related household apparatus

FEATURES

- Isolation test voltage 5300 V_{RMS}
- Extra low coupling capacity - typical 0.2 pF
- High common mode rejection
- No base terminal connection for improved noise immunity
- CTR offered in 4 groups
- Thickness through insulation ≥ 0.75 mm
- Creepage current resistance according to VDE 0303/ IEC 60112 comparative tracking index: CTI ≥ 275
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



RoHS
COMPLIANT

APPLICATIONS

- Switch-mode power supplies
- Line receiver
- Computer peripheral interface
- Microprocessor system interface
- Circuits for safe protective separation against electrical shock according to safety class II (reinforced isolation):
- for appl. class I - IV at mains voltage ≤ 300 V
- for appl. class I - III at mains voltage ≤ 600 V according to DIN EN 60747-5-5.

AGENCY APPROVALS

- UL1577, file no. E76222 system code A, double protection
- BSI IEC 60950; IEC 60065
- DIN EN 60747-5-5
- FIMKO

| ORDER INFORMATION | |
|-------------------|-------------------------|
| PART | REMARKS |
| TCDT1100 | CTR > 40 %, DIP-6 |
| TCDT1101 | CTR 40 to 80 %, DIP-6 |
| TCDT1102 | CTR 63 to 125 %, DIP-6 |
| TCDT1103 | CTR 100 to 200 %, DIP-6 |
| TCDT1100G | CTR > 40 %, DIP-6 |
| TCDT1101G | CTR 40 to 80 %, DIP-6 |
| TCDT1102G | CTR 63 to 125 %, DIP-6 |
| TCDT1103G | CTR 100 to 200 %, DIP-6 |

Note

G = leadform 10.16 mm; G is not marked on the body.



| ABSOLUTE MAXIMUM RATINGS (1) | | | | |
|-------------------------------------|-------------------------------|------------|---------------|-----------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| INPUT | | | | |
| Reverse voltage | | V_R | 5 | V |
| Forward current | | I_F | 60 | mA |
| Forward surge current | $t_p \leq 10 \mu s$ | I_{FSM} | 3 | A |
| Power dissipation | | P_{diss} | 100 | mW |
| Junction temperature | | T_j | 125 | °C |
| OUTPUT | | | | |
| Collector emitter voltage | | V_{CEO} | 32 | V |
| Emitter collector voltage | | V_{ECO} | 7 | V |
| Collector current | | I_C | 50 | mA |
| Collector peak current | $t_p/T = 0.5, t_p \leq 10 ms$ | I_{CM} | 100 | mA |
| Power dissipation | | P_{diss} | 150 | mW |
| Junction temperature | | T_j | 125 | °C |
| COUPLER | | | | |
| Isolation test voltage (RMS) | | V_{ISO} | 5300 | V_{RMS} |
| Total power dissipation | | P_{tot} | 250 | mW |
| Ambient temperature range | | T_{amb} | - 55 to + 100 | °C |
| Storage temperature range | | T_{stg} | - 55 to + 125 | °C |
| Soldering temperature (2) | 2 mm from case, $t \leq 10 s$ | T_{sld} | 260 | °C |

Notes(1) $T_{amb} = 25 \text{ }^\circ\text{C}$, unless otherwise specified.

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

(2) Refer to wave profile for soldering conditions for through hole devices.

| ELECTRICAL CHARACTERISTICS | | | | | | |
|--------------------------------------|---|-------------|------|------|------|------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| INPUT | | | | | | |
| Forward voltage | $I_F = 50 \text{ mA}$ | V_F | | 1.25 | 1.6 | V |
| Junction capacitance | $V_R = 0, f = 1 \text{ MHz}$ | C_j | | 50 | | pF |
| OUTPUT | | | | | | |
| Collector emitter voltage | $I_C = 1 \text{ mA}$ | V_{CEO} | 32 | | | V |
| Emitter collector voltage | $I_E = 100 \mu\text{A}$ | V_{ECO} | 7 | | | V |
| Collector emitter cut-off current | $V_{CE} = 20 \text{ V}, I_F = 0, E = 0$ | I_{CEO} | | 200 | | nA |
| COUPLER | | | | | | |
| Collector emitter saturation voltage | $I_F = 10 \text{ mA}, I_C = 1 \text{ mA}$ | V_{CEsat} | | | 0.3 | V |
| Cut-off frequency | $V_{CE} = 5 \text{ V}, I_F = 10 \text{ mA}, R_L = 100 \Omega$ | f_c | | 110 | | kHz |
| Coupling capacitance | $f = 1 \text{ MHz}$ | C_k | | 0.3 | | pF |

Note $T_{amb} = 25 \text{ }^\circ\text{C}$, unless otherwise specified.

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.



| CURRENT TRANSFER RATIO | | | | | | | |
|------------------------|---|-----------|--------|------|------|------|------|
| PARAMETER | TEST CONDITION | PART | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| I_C/I_F | $V_{CE} = 5\text{ V}, I_F = 10\text{ mA}$ | TCDT1100 | CTR | 40 | | | % |
| | | TCDT1100G | CTR | | | | % |
| | | TCDT1101 | CTR | 40 | | 80 | % |
| | | TCDT1101G | CTR | | | | % |
| | | TCDT1102 | CTR | 63 | | 125 | % |
| | | TCDT1102G | CTR | | | | % |
| | | TCDT1103 | CTR | 100 | | 200 | % |
| | | TCDT1103G | CTR | | | | % |

| MAXIMUM SAFETY RATINGS | | | | | | |
|------------------------|----------------|------------|------|------|------|------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| INPUT | | | | | | |
| Forward current | | I_F | | | 130 | mA |
| OUTPUT | | | | | | |
| Power dissipation | | P_{diss} | | | 265 | mW |
| COUPLER | | | | | | |
| Rated impulse voltage | | V_{IOTM} | | | 6 | kV |
| Safety temperature | | T_{si} | | | 150 | °C |

Note

According to DIN EN 60747-5-5 (see figure 1). This optocoupler is suitable for safe electrical isolation only within the safety ratings. Compliance with the safety ratings shall be ensured by means of suitable protective circuits.

| INSULATION RATED PARAMETERS | | | | | | |
|---|--|------------|-----------|------|------|----------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Partial discharge test voltage - routine test | 100 %, $t_{test} = 1\text{ s}$ | V_{pd} | 1.6 | | | kV |
| Partial discharge test voltage - lot test (sample test) | $t_{Tr} = 60\text{ s}, t_{test} = 10\text{ s},$ (see figure 2) | V_{IOTM} | 6 | | | kV |
| | | V_{pd} | 1.3 | | | kV |
| Insulation resistance | $V_{IO} = 500\text{ V}$ | R_{IO} | 10^{12} | | | Ω |
| | $V_{IO} = 500\text{ V}, T_{amb} = 100\text{ °C}$ | R_{IO} | 10^{11} | | | Ω |
| | $V_{IO} = 500\text{ V}, T_{amb} = 150\text{ °C}$ (construction test only) | R_{IO} | 10^9 | | | Ω |

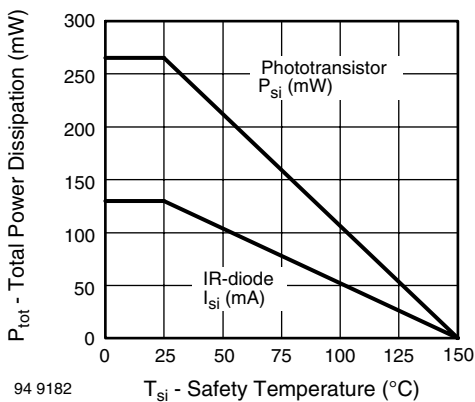


Fig. 1 - Derating Diagram

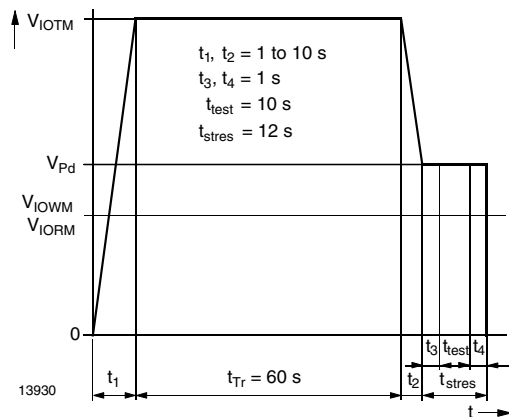


Fig. 2 - Test Pulse Diagram for Sample Test According to DIN EN 60747-5-5/DIN EN 60747-; IEC60747

| SWITCHING CHARACTERISTICS | | | | | | |
|---------------------------|---|-----------|------|------|------|---------------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Delay time | $V_S = 5\text{ V}$, $I_C = 5\text{ mA}$, $R_L = 100\ \Omega$, (see figure 3) | t_d | | 4.0 | | μs |
| Rise time | $V_S = 5\text{ V}$, $I_C = 5\text{ mA}$, $R_L = 100\ \Omega$, (see figure 3) | t_r | | 7.0 | | μs |
| Fall time | $V_S = 5\text{ V}$, $I_C = 5\text{ mA}$, $R_L = 100\ \Omega$, (see figure 3) | t_f | | 6.7 | | μs |
| Storage time | $V_S = 5\text{ V}$, $I_C = 5\text{ mA}$, $R_L = 100\ \Omega$, (see figure 3) | t_s | | 0.3 | | μs |
| Turn-on time | $V_S = 5\text{ V}$, $I_C = 5\text{ mA}$, $R_L = 100\ \Omega$, (see figure 3) | t_{on} | | 11.0 | | μs |
| Turn-off time | $V_S = 5\text{ V}$, $I_C = 5\text{ mA}$, $R_L = 100\ \Omega$, (see figure 3) | t_{off} | | 7.0 | | μs |
| Turn-on time | $V_S = 5\text{ V}$, $I_C = 10\text{ mA}$, $R_L = 1\text{ k}\Omega$, (see figure 4) | t_{on} | | 25.0 | | μs |
| Turn-off time | $V_S = 5\text{ V}$, $I_C = 10\text{ mA}$, $R_L = 1\text{ k}\Omega$, (see figure 4) | t_{off} | | 42.5 | | μs |

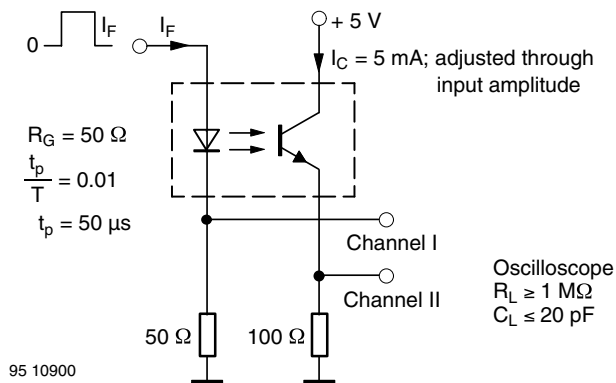


Fig. 3 - Test Circuit, Non-Saturated Operation

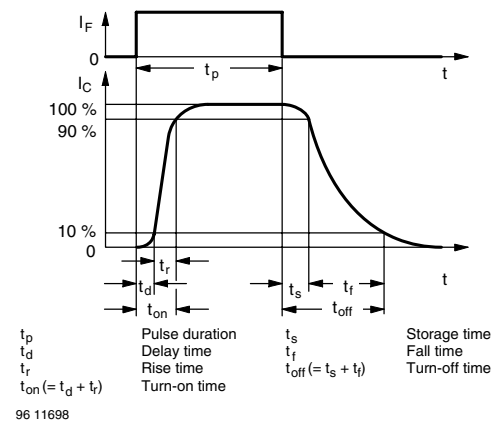


Fig. 5 - Switching Times

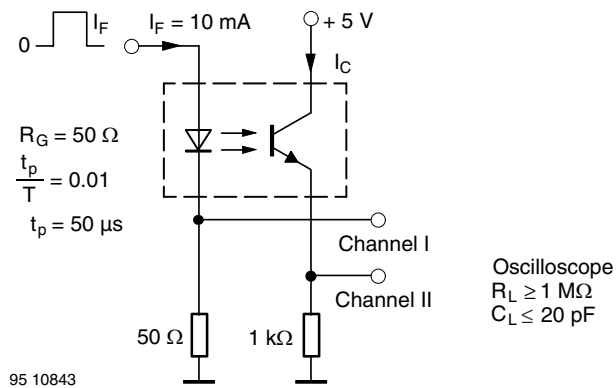


Fig. 4 - Test Circuit, Saturated Operation

TYPICAL CHARACTERISTICS

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

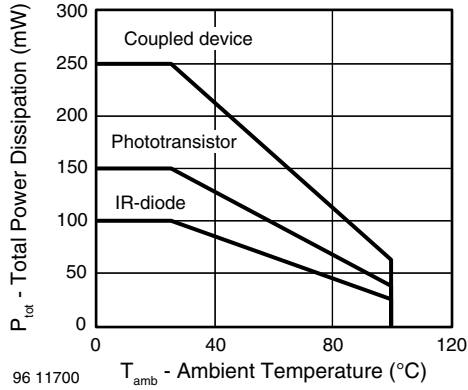


Fig. 6 - Total Power Dissipation vs. Ambient Temperature

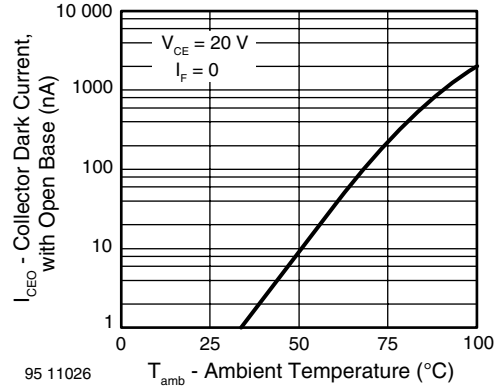


Fig. 9 - Collector Dark Current vs. Ambient Temperature

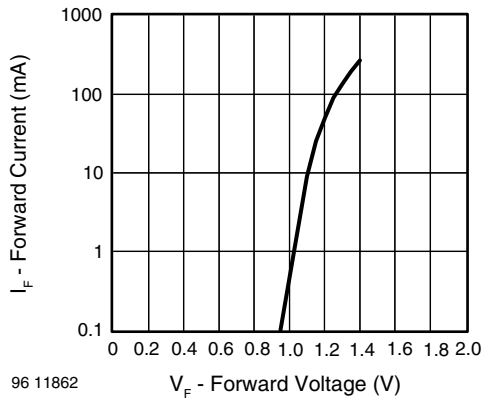


Fig. 7 - Forward Current vs. Forward Voltage

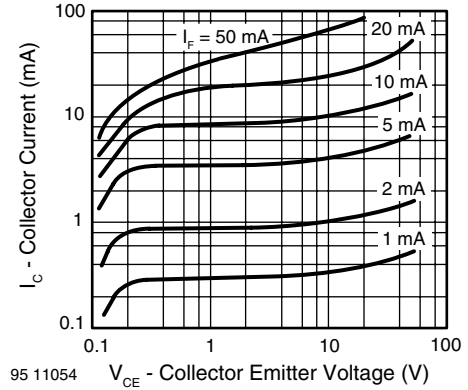


Fig. 10 - Collector Current vs. Collector Emitter Voltage

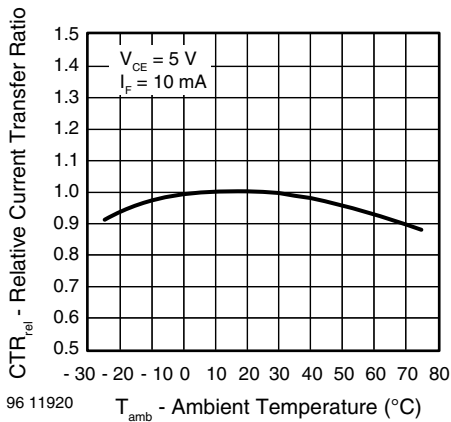


Fig. 8 - Relative Current Transfer Ratio vs. Ambient Temperature

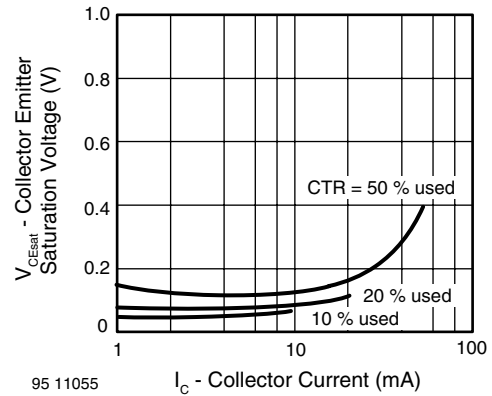


Fig. 11 - Collector Emitter Saturation Voltage vs. Collector Current

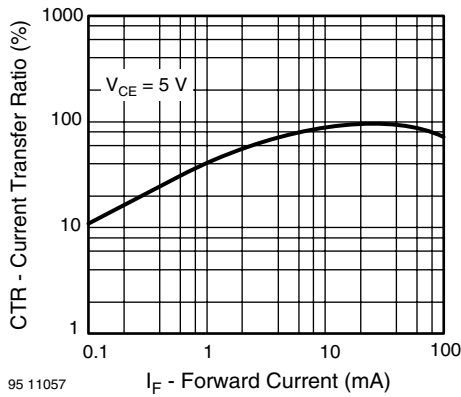


Fig. 12 - Current Transfer Ratio vs. Forward Current

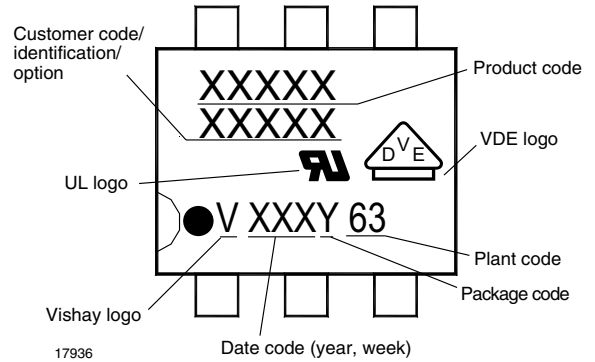


Fig. 15 - Marking Example

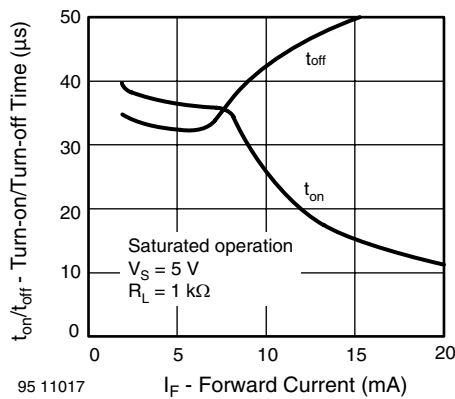


Fig. 13 - Turn-on/off Time vs. Forward Current

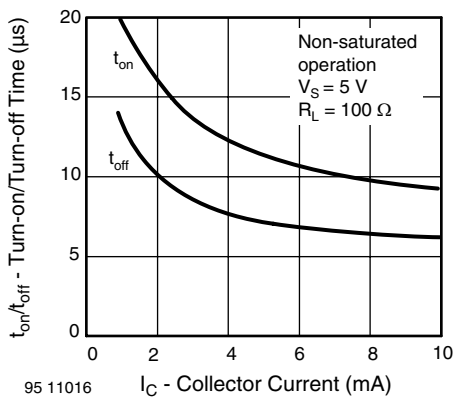


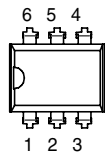
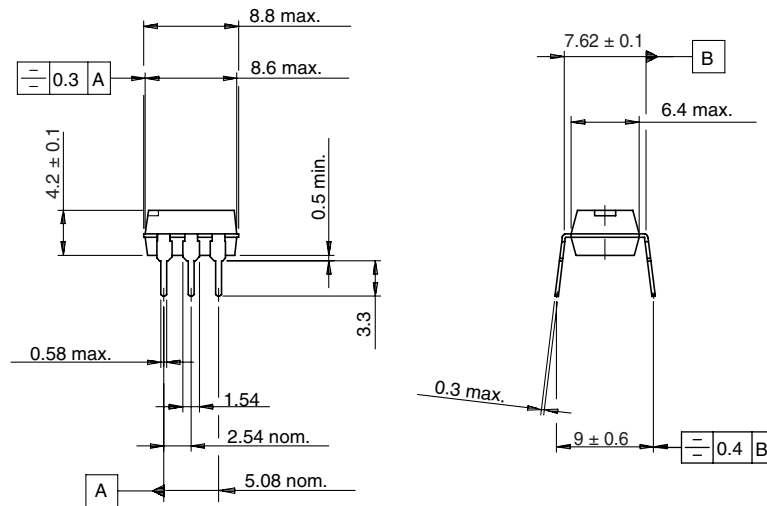
Fig. 14 - Turn-on/off Time vs. Collector Current

TCDT1100/TCDT1100G

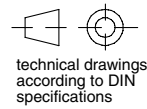
Vishay Semiconductors Optocoupler, Phototransistor Output



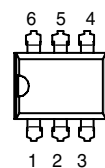
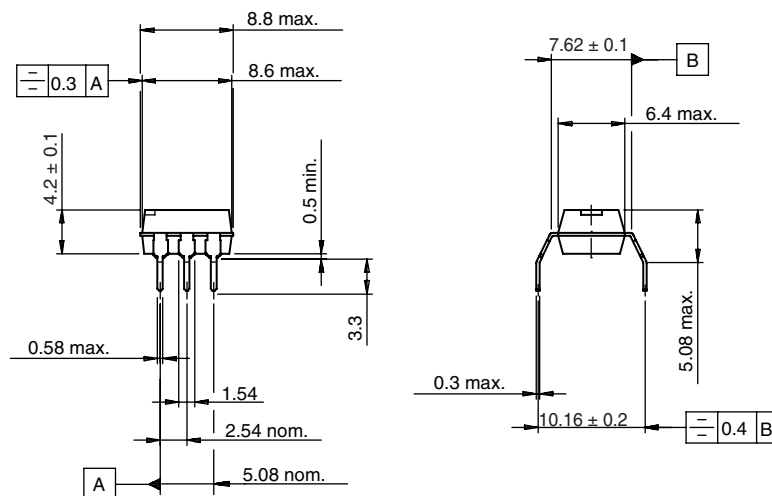
PACKAGE DIMENSIONS in millimeters



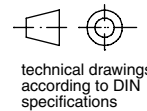
Weight: ca. 0.50 g
 Creepage distance: > 6 mm
 Air path: > 6 mm
 after mounting on PC board



14770



Weight: ca. 0.50 g
 Creepage distance: > 8 mm
 Air path: > 8 mm
 after mounting on PC board



14771

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